Innovative Service Around the Globe

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

C-Array NP0/X7R/Y5V

16 V TO 50 V sizes 0508 (4 x 0402) / 0612 (4 x 0603)

RoHS compliant & Halogen Free



YAGEO Phícomp



<u>SCOPE</u>

This specification describes NP0/X7R/Y5V 4-capacitor Array with lead-free terminations.

APPLICATIONS

- Professional electronics
- High density consumer electronics

FEATURES

- Supplied in tape on reel
- · Nickel-barrier end termination
- 0508 (4x0402) / 0612 (4x0603) capacitors (of the same capacitance value) per array
- Less than 50% board space of an equivalent discrete component
- High volumetric efficiency
- Increased throughout, by time saved in mounting
- · RoHS compliant
- Halogen Free compliant

ORDERING INFORMATION-GLOBAL PART NUMBER, PHYCOMP CTC & 12NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value. Please note that 12 digits ordering code will expire at the end of 2010.

YAGEO BRAND ordering code GLOBAL PART NUMBER (PREFERRED)

CA <u>xxxx</u> <u>x x xxx x B x xxx</u> (1) (2) (3) (4) (5) (6) (7)

(I) SIZE – INCH BASED (METRIC)

0508 (1220)

0612 (1632)

(2) TOLERANCE

 $| = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

Z = -20% to +80%

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

X5R

X7R

Y5V

(5) RATED VOLTAGE

7 = 16 V

8 = 25 V

9 = 50 V

0 = 100 V

(6) PROCESS

N = NP0

B = class 2 material

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

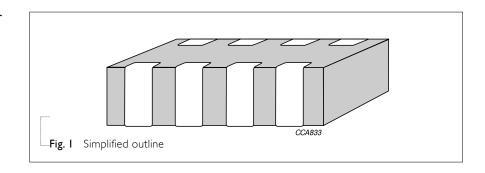
Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn).

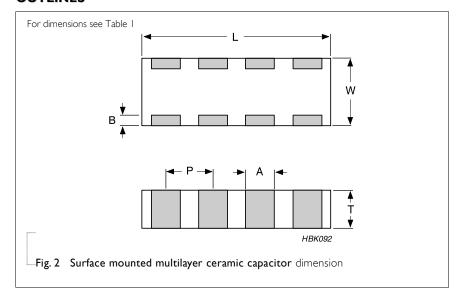
The terminations are lead-free. An outline of the structure is shown in Fig.I.



DIMENSIONS

Table I		
TYPE	0508	0612
	(4 X 0402)	(4 X 0603)
L (mm)	2.0 ±0.15	3.2 ±0.15
W (mm)	1.25 ±0.15	1.60 ±0.15
$T_{min.}$ (mm)	Refer to Table	2 ~ Table 4
$T_{\text{max.}}$ (mm)	Refer to Table	2 ~ Table 4
A (mm)	0.28 ±0.10	0.4 ±0.10
B (mm)	0.2 ±0.10	0.3 ±0.20
P (mm)	0.5 ±0.10	0.8 ±0.10

OUTLINES





YAGEO Phicomp

Surface-Mount Ceramic Multilayer Capacitors 4C-Arroy

NP0/X7R/Y5V

16 V to 50 V

<u>4</u>

CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 2 Temperature characteristic material from NP0

CAPACITANCE	0508 (4 x 0402)		0612 (4 × 0603)	
	50 V	100V	50 V	100V
10 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
15 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
18 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
22 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
33 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
39 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
47 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
56 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
68 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
82 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
100 pF	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1
120 pF	0.6±0.1		0.8±0.1	0.8±0.1
150 pF	0.6±0.1		0.8±0.1	0.8±0.1
180 pF	0.6±0.1		0.8±0.1	0.8±0.1
220 pF	0.6±0.1		0.8±0.1	0.8±0.1
270 pF			0.8±0.1	0.8±0.1
330 pF			0.8±0.1	0.8±0.1
390 pF			0.8±0.1	0.8±0.1
470 pF			0.8±0.1	0.8±0.1
560 pF				
680 pF				
820 pF				
I.0 nF				

NOTE

Values in shaded cells indicate thickness class in mm

CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 3 Temperature characteristic material from X7R

CAPACITANCE	0508 (4 × 0402)	0612 (4 × 0603)					
	16 V	25 V	50 V	16 V	25 V	50 V	100V
220 pF				0.8±0.1	0.8±0.1	0.8±0.1	
330 pF				0.8±0.1	0.8±0.1	0.8±0.1	
470 pF				0.8±0.1	0.8±0.1	0.8±0.1	
680 pF				0.8±0.1	0.8±0.1	0.8±0.1	
I.O nF	0.6±0.1	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1	0.8±0.1	
I.2 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
1.5 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
I.8 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
2.2 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
2.7 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
3.3 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
3.9 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
4.7 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
5.6 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
6.8 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
8.2 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	
10 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1	0.85±0.1
12 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	0.85±0.1
15 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	0.85±0.1
18 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	0.85±0.1
22 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	0.85±0.1
27 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
33 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
47 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
56 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
68 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
82 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
100 nF	0.6±0.1			0.8±0.1	0.8±0.1	0.8±0.1	
220 nF				0.8±0.1			
470 nF				0.8±0.1			

NOTE

Values in shaded cells indicate thickness class in mm

CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 4 Temperature characteristic material from Y5V

CAPACITANCE 0612 (4 x 0603)

25 V

10 nF	
22 nF	
47 nF	0.6±
100 nF	

NOTE

Values in shaded cells indicate thickness class in mm

THICKNESS CLASSES AND PACKING QUANTITY

Table 5				
SIZE	THICKNESS	TAPE WIDTH QUANTITY	Ø180 MM / 7 INCH	Ø180 MM / 13 INCH
CODE	CLASSIFICATION	PER REEL	Paper	Paper
0508	0.6 ±0.1 mm	8 mm	4,000	20,000
0612	0.8 ±0.1 mm	8 mm	4,000	15,000

NP0/X7R/Y5V

16 V to 50 V

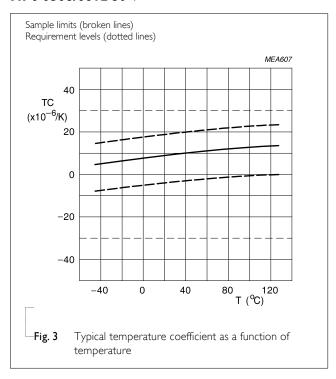
ELECTRICAL CHARACTERISTICS

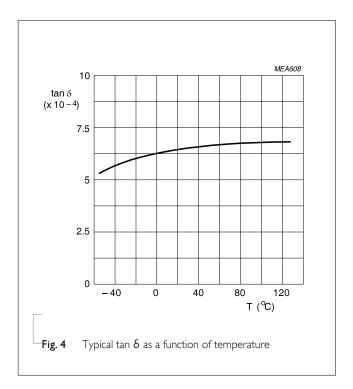
4C-ARRAY DIELECTRIC CAPACITORS; NISN TERMINATIONS

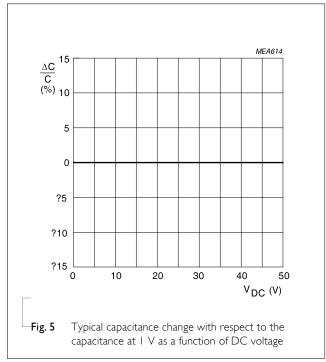
Unless otherwise stated all electrical values apply at an ambient temperature of $20\pm 1\,$ °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

Table 6		
DESCRIPTION		VALUE
Capacitance range		10 pF to 100 nF
Rated voltage		
	NP0	50 V
	X7R	16 V to 50 V
	Y5V	0612: 25 V
Capacitance tolerance		
	NP0	±5%, ±10%
	X7R	±10%, ±20%
	Y5V	-20% to +80%
Dissipation factor (D.F.)		
	NP0	≤ 0.1%
	X7R	16 V ≤ 3.5%, 25V ≤ 2.5%, 50V ≤ 2.5% 0508/12nF~100nF/16V, Df ≤5%
	Y5V	0508 ≤ 9%, 0612 ≤ 7%
Insulation resistance after I minute at U_r (DC)		$R_{ins} \ge 10 \text{ G}\Omega$ or $R_{ins} \times C_r \ge 500$ seconds whichever is less
Maximum capacitance change as a function of temperatu (temperature characteristic/coefficient):	re	
	NP0	±30 ppm/°C
	X7R	±15%
	Y5V	+22% to -82%
Operating temperature range:		
	NP0	-55 °C to +125 °C
	X7R	–55 °C to +125 °C
	Y5V	-30 °C to +85 °C

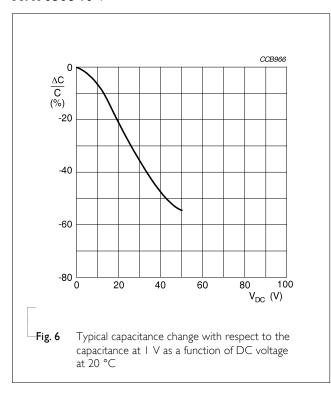
NP0 0508/0612 50 V

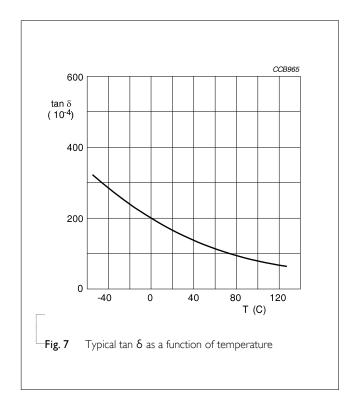


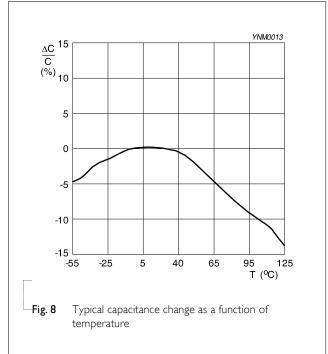




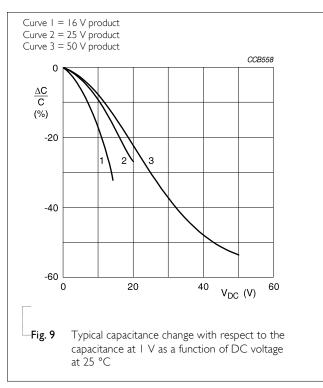
X7R 0508 16 V

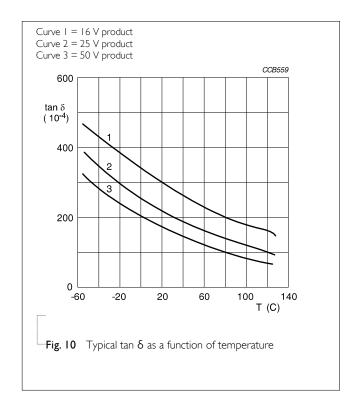


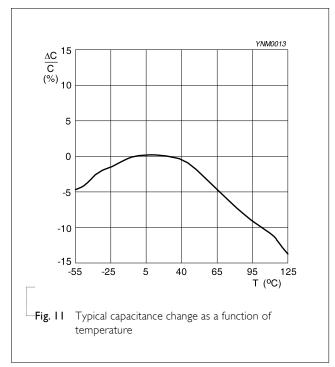




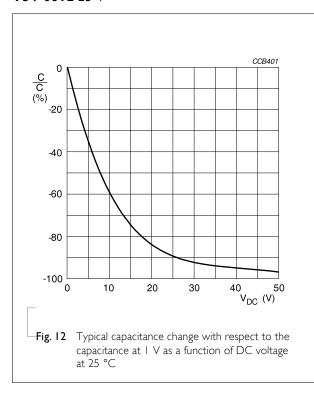
X7R 0612 16 V to 50 V

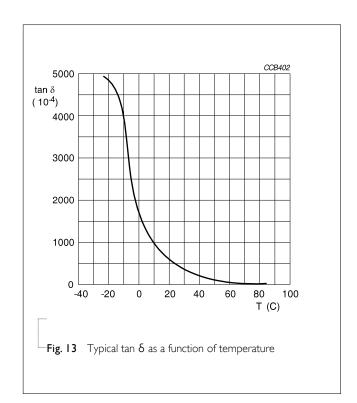


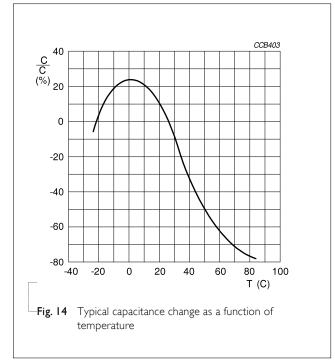




Y5V 0612 25 V







TESTS AND REQUIREMENTS

Table 7 Test procedures and requirements

TEST	TEST MET	HOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance		4.5.1	Class I: $f = I \text{ MHz for C} \leq I \text{ nF, measuring at voltage I V}_{rms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for C} > I \text{ nF, measuring at voltage I V}_{rms} \text{ at } 20 \text{ °C}$ Class 2: $f = I \text{ KHz for C} \leq I0 \mu\text{F, measuring at voltage I V}_{rms} \text{ at } 20 \text{ °C}$ $f = I20 \text{ Hz for C} > 10 \mu\text{F, measuring at voltage } 0.5 \text{ V}_{rms} \text{ at } 20 \text{ °C}$	Within specified tolerance
Dissipation Factor (D.F.)		4.5.2	Class I: $f = I \text{ MHz for } C \leq I \text{ nF , measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for } C > I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ Class 2: $f = I \text{ KHz for } C \leq I0 \mu\text{F, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ $f = I20 \text{ Hz for } C > I0 \mu\text{F, measuring at voltage } 0.5 \text{ V}_{rms} \text{ at } 20 \text{ °C}$	In accordance with specification
Insulation Resistance		4.5.3	At U _r (DC) for I minute	In accordance with specification

Surface-Mount Ceramic Multilayer Capacitors 4C-Array NPO/X7R/Y5V

16 V to 50 V

TEST	TEST METHOD	PROCED	URE	REQUIREMENTS
Temperature Coefficient	4.6	Capacitan table. The capacities specified t	Class I: Δ C/C: ±30ppm Class 2: X7R: Δ C/C: ±15% Y5V: Δ C/C: 22~-82%	
		Step	Temperature(°C)	
		a	25±2	
		b	Lower temperature±3°C	
		С	25±2	
		d	Upper Temperature±2° C	
		е	25±2	
		(I) Class		
		Temperat below	ure Coefficient shall be calculated from the formula as	
		Temp, Co	efficient = $\frac{C2 - C1}{C1 \times \Delta T} \times 10^6 \text{ [ppm/°C]}$	
		C1: Capad	itance at step c	
		C2: Capac	itance at 125°C	
		ΔT: 100°	C(=125°C-25°C)	
		(2) Class	II	
		Capacitan	ce Change shall be calculated from the formula as below	
		$\Delta C = \frac{C2}{C}$	<u>-CI</u> × 100%	
		C1: Capad	itance at step c	
		C2: Capac	itance at step b or d	
Adhesion	4.7		oplied for 10 seconds to the line joining the terminations	Force

and in a plane parallel to the substrate

size ≥ 0603: 5N

size = 0402: 2.5N size = 0201: 1N

16 V to 50 V

TEST	TEST MET	HOD	PROCEDURE	REQUIREMENTS
Bond Strength of	IEC 60384- 21/22	4.8	Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage
Plating on End Face			Conditions: bending I mm at a rate of I mm/s, radius jig 5 mm	Δ C/C Class 1: NP0: within $\pm 1\%$ or 0.5 pF, whichever is greater
				Class2: X5R/X7R/Y5V: ±10%
Resistance to Soldering Heat		4.9	Precondition: 150 +0/-10 °C for I hour, then keep for 24 ±1 hours at room temperature Preheating: for size ≤ 1206: 120 °C to 150 °C for I minute	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
		Preheating: for size > 1206: 100 °C to 120 °C for I minute and 170 °C to 200 °C for I minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds	Δ C/C Class I: NP0: within $\pm 0.5\%$ or 0.5 pF, whichever is greater Class2:	
			Recovery time: 24 ±2 hours	X5R/X7R: ±10% Y5V: ±20%
				D.F. within initial specified value R _{ins} within initial specified value
Solderability		4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination
			Test conditions for lead containing solder alloy Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds Depth of immersion: 10 mm Alloy Composition: 60/40 Sn/Pb Number of immersions: 1 Test conditions for leadfree containing solder alloy Temperature: 245 ±5 °C Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm Alloy Composition: SAC305 Number of immersions: 1	

16 V to 50 V

TEST	TEST METI	HOD	PROCEDURE	REQUIREMENTS
Rapid Change of	IEC 60384- 21/22	4.11	Preconditioning; I50 +0/–I0 °C for I hour, then keep for	No visual damage
Temperature			24 ±1 hours at room temperature	Δ C/C Class 1: NP0: within ±1% or 1 pF, whichever is greater
			5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature	Class2: X5R/X7R: ±15% Y5V: ±20%
			Recovery time 24 ±2 hours	D.F. meet initial specified value
				R _{ins} meet initial specified value
Damp Heat with U _r Load		4.13	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for	No visual damage after recovery
			24 ±1 hour at room temp	ΔC/C
			2. Initial measure:	Class I:
			Spec: refer initial spec C, D, IR	NP0: within ±2% or 1 pF, whichever is greater
			3. Damp heat test:	Class2:
			500 \pm 12 hours at 40 \pm 2 °C;	X5R/X7R: ±15%; Y5V: ±30%
			90 to 95% R.H. I.O U _r applied	D.F.
			4. Recovery:	Class 1: NP0: ≤ 2 × specified value
			Class 1: 6 to 24 hours	Class2:
			Class 2: 24 ±2 hours	X5R/X7R: ≤ 16V: ≤ 7%
			5. Final measure: C, D, IR	≥ 25V: ≤ 5%
			P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and then the requirement shall be met.	Y5V: \leq 15% R_{ins} Class 1: $NP0: \geq 2,500 \ M\Omega \ or \ R_{ins} \times C_r \geq 25s \ whichever \ is \ less$ Class2: $X5R/X7R/Y5V: \geq 500 \ M\Omega \ or \ R_{ins} \times C_r \geq 25s$ whichever is less

16 V to 50 V

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Endurance IEC 60384- 21/22 1. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ± I hour at room temp 2. Initial measure: Spec: refer initial spec C, D, IR 3. Endurance test: Temperature: NP0/X7R: 125 °C X5R/Y5V: 85 °C Specified stress voltage applied for I,000 ho Applied 2.0 × U _r for general product. 4. Recovery time: 24 ± 2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitors.	IEC 60384- 4.14	 I. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp Initial measure: Spec: refer initial spec C, D, IR Endurance test: Temperature: NP0/X7R: 125 °C	No visual damage
	minimum value permitted, then after the other measurements have been made the capacitor shall be precondition according to "IEC 60384 4.1" and		
Voltage Proof	IEC 60384-I 4.6	Specified stress voltage applied for 1 minute $U_r \le 100 \text{ V}$: series applied 2.5 U_r $100 \text{ V} < U_r \le 200 \text{ V}$ series applied (1.5 $U_r + 100$) $200 \text{ V} < U_r \le 500 \text{ V}$ series applied (1.3 $U_r + 100$) $U_r > 500 \text{ V}$: 1.3 U_r 1: 7.5 mA	No breakdown or flashover

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 5	Jun. 16, 2017	-	- X7R/0612 product range updated
Version 4	Nov. 10, 2015	-	- Product range updated
Version 3	May 21, 2014	-	- Product range updated
Version 2	Jun. 17, 2013	-	- Product range updated
Version I	Feb 05, 2010	-	- The statement of "Halogen Free" on the cover added
Version 0	Jun 22, 2009	-	- New datasheet for 4C-Array series with RoHS compliant
			- Replace from pdf files: 0508_16V to 50V_1, 0612_16V to 50V_0, C-Array_NP0_50V_0508_7, C-Array_NP0_50V_0612_7, C-Array_X7R_16V_25V_50V_0612_6, C-Array_X7R_16V_0508_5, C-Array_Y5V_25V_0508_0, C-Array_Y5V_25V_0612_5
			- Define global part number
			- Description of "Halogen Free compliant" added
			- Test method and procedure updated

